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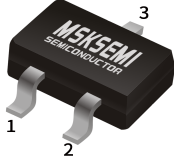


PLED

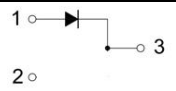
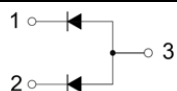
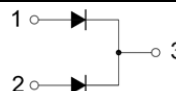
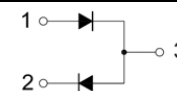




Product data sheet

**FEATURES**

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automatic Insertion
- For General Purpose Switching Applications
- High Conductance



**SOT-23**

BAS21	BAS21A	BAS21C	BAS21S
			
<b>MARKING: JS</b>	<b>MARKING: JS2</b>	<b>MARKING: JS3</b>	<b>MARKING: JS4</b>
			

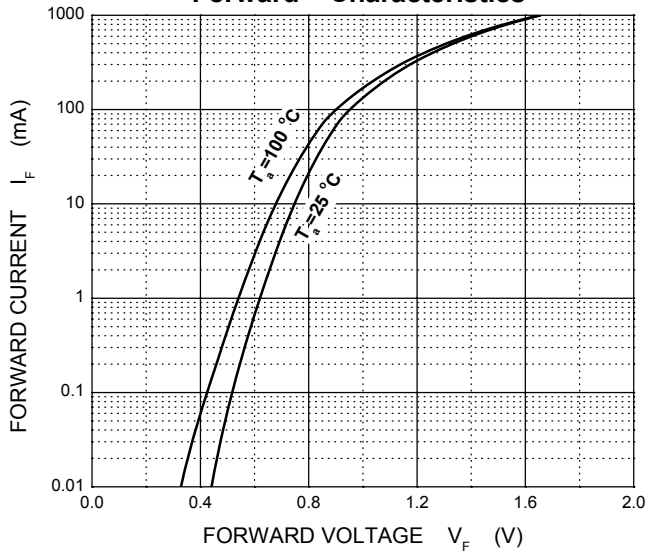
**Maximum Ratings @Ta=25°C**

Parameter	Symbol	Limit	Unit
Repetitive peak reverse voltage	$V_{RRM}$	250	V
Working peak reverse voltage	$V_{RWM}$		
DC blocking voltage	$V_R$		
Forward continuous current	$I_{FM}$	400	mA
Average rectified output current	$I_O$	200	mA
Non-Repetitive Peak Forward Surge Current @ t=8.3ms	$I_{FSM}$	2.5	A
Repetitive peak forward surge current	$I_{FRM}$	625	mA
Power dissipation	$P_D$	225	mW
Thermal resistance junction to ambient	$R_{\theta JA}$	555	°C/W
Junction temperature	$T_J$	150	°C
Storage temperature range	$T_{STG}$	-55~+150	°C

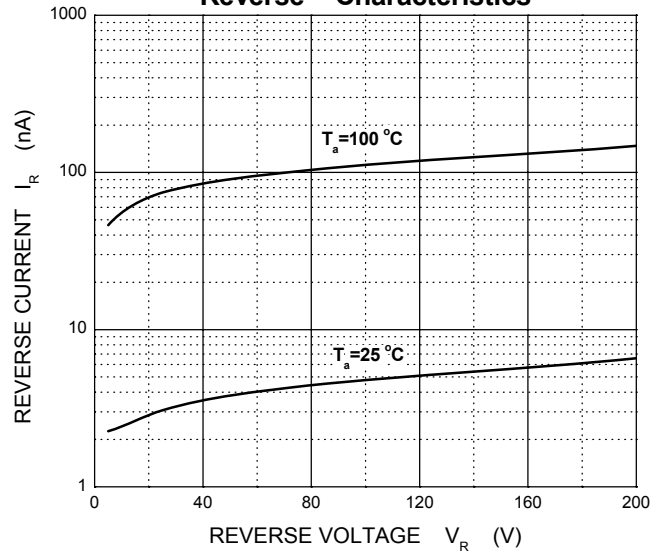
**ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)**

Parameter	Symbol	Test conditions	Min	Max	Unit
Reverse breakdown voltage	$V_{(BR)}$	$I_R = 100\mu A$	250		V
Reverse voltage leakage current	$I_R$	$V_R = 200V$		0.1	$\mu A$
Forward voltage	$V_F$	$I_F = 100mA$ $I_F = 200mA$		1000 1250	mV
Diode capacitance	$C_D$	$V_R = 0V, f = 1MHz$		5	pF
Reverse recovery time	$t_{rr}$	$I_F = I_R = 30mA, I_{tr} = 0.1 \times I_R, R_L = 100 \Omega$		50	ns

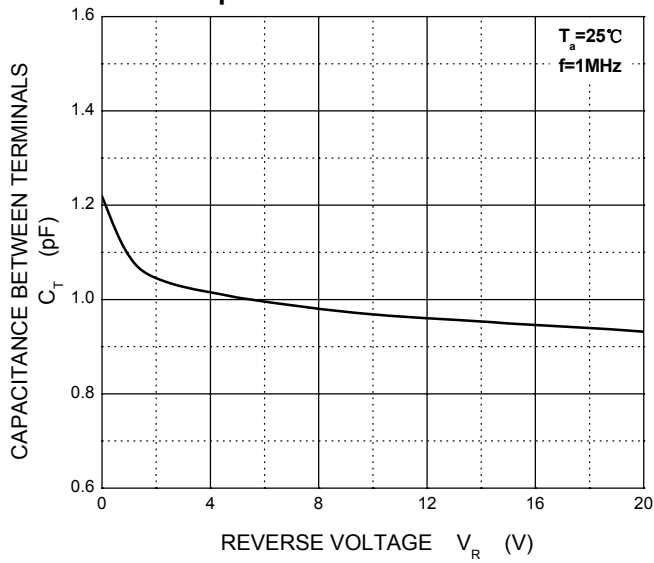
**Forward Characteristics**



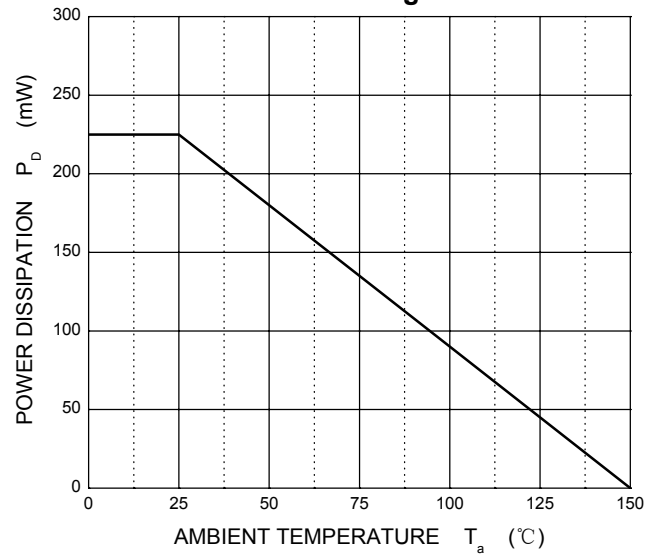
**Reverse Characteristics**



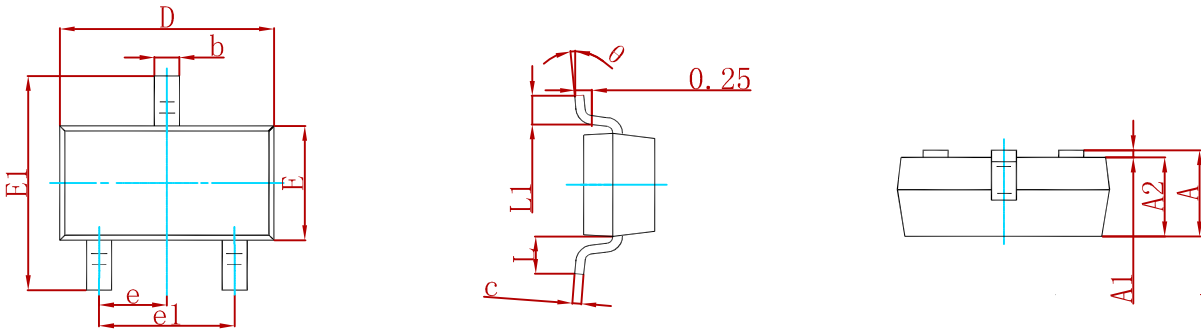
**Capacitance Characteristics**



**Power Derating Curve**

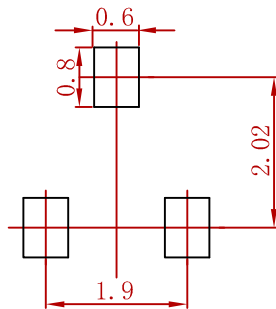


**PACKAGE MECHANICAL DATA**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

**Suggested Pad Layout**



- Note:
1. Controlling dimension: in millimeters.
  2. General tolerance: ± 0.05mm.
  3. The pad layout is for reference purposes only.

**REEL SPECIFICATION**

P/N	PKG	QTY
BAS21/A/C/S	SOT-23	3000

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